Name:

Enrolment No:

UNIVERSITY OF PETROLEUM AND ENERGY STUDIES End Semester Examination, April/May 2018

SECTION A $(4 \times 5 = 20 \text{ Marks})$

Course: Embedded Systems (ELEG-464) Program: B.Tech Instrumentation & Control Engineering Time: 03 hrs. Semester: VIII

Max. Marks: 100

Instructions: Assume necessary data in programming if required.

S. No.	Attempt All the questions	Marks	CO
Q.1	What is Embedded System? Comment on the design matrices for the product development in embedded system?	4	CO1
Q.2	Comments on the different data types used in 801 Embedded 'C' programming. Write an 8051 C program to send the hex values for the ASCII characters of 0, 1, 2, 3, 4, 5, A, B, C and D to port P1.	4	CO4
Q.3	Comment on the different addressing modes employed in 8051 microcontroller. Examine the stack for 8051 microcontroller. Show the contents of the register and SP after execution of PUSH 4 instructions. All values are in hex. After PUSH 2 After PUSH 1 After PUSH 4 63 62 61 61 61 61 60 25 60 2560 2560 2560 2560 2560 2560 2560 2560 25	4	CO3
Q.4	Assume that the word "UPES" is burned into ROM locations starting at 200H and the program is burned into ROM locations starting at 0. Analyze the method to support the program functionality and state where "UPES" is stored after this program is run, also develop the code for same. OR Draw the structure for assembly language program flow and discuss the steps to burn the program in microcontroller.	4	CO3
Q.5	Find the time delay generated by the following subroutine for 8051 microcontroller, If XTAL = 11.0592 MHz. HERE: MOV R0, # 200 AGAIN: DJNZ R0, AGAIN RET Suggest the best techniques to increase the delay obtained for the subroutine and estimate value.	4	CO5



	SECTION B (8 x 5 = 40 Marks)				
	Attempt All the questions				
Q.6					
Q.7	Draw the block diagram of 8051 microcontroller and pin layout with the complete description of each pin and units of block.	8	CO1		
Q.8	What is Semaphore? Explain the different types of Semaphore.	8	CO2		
Q.9	Develop the data path architecture for the GCD controller for the two numbers $X = 40$ and $Y = 50$. Discuss the state table and FSMD. Also compare the custom GCD with the GCD running on a 300 MHz processor with two operand inductions and one clock cycle per instruction.	8	CO2		
Q.10	Interface the stepper motor to 8051 microcontroller with the help of optoisolator. A switch is connected to pin 2.7 of 8051 microcontroller. Write a program to monitor the status of switch and perform the followings (a) If SW = 0, the stepper motor moves clockwise. (b) If SW= 1, the stepper motor moves counterclockwise.	8	CO5		
	SECTION-C (20 x 2 = 40 Marks)				
	Attempt any two of the followings (Case Studies)				
Q.11	The interfacing of a hex keypad to 8051/8085 microcontroller/ microprocessor is very essential while designing embedded system projects which requires character or numeric input or both. For examples projects like digital code lock, numeric calculator etc. f(1) = (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) + (1 + 1) +	20	CO3		

	the key are connected gets C1 gets shorted and so or known as column scannin kept high) and the colum then that means that the row (the row that is kept low and column C1 is fou (a) Based on the discusse (b) WAP to display all the and microcontroller						
Q.12	and microcontroller. Programming a 7-Segme pattern should be generat with cascaded mode we all pins of port two in order t on Port zero which can ge in fig. 3(a) below.	e in a manner lso need to ser o enable or di nerate meanir	so as it append "clear" (0) sable respectingful character 000 LSB x0 0100 0 0101 0	ears as a mean or "set bit" (1 ed 7-Segment ers on 7-Segm 00 LSB x000 1100 0 1110 0 1110	ingful character and) signal on respected display. The signals ent display are listed	20	CO4
	0011	0_0	ttern of 7 seg	JI U			
	Fig 3(b) Output						
	(a) Develop the Embedded 'C' code or assembly program to support output shown in fig. 1(b) with interface the 8051 microcontroller using one segment.						
	(b) Draw and discuss the interface diagram with the four segments and method of displaying the output.						
	(c) Replace the Seven So write embedded 'C'c	-			face diagram and		

Q.13 Digital systems and microcontroller pins lack sufficient current to drive the relay. While the relay's coil needs around 10 mA to be energized, the microcontroller's pin can provide a maximum of 1-2 mA current. For this reason, we place a driver, such as the ULN2803, or a power transistor between the microcontroller and the relay as shown in Fig.4

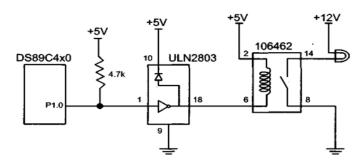
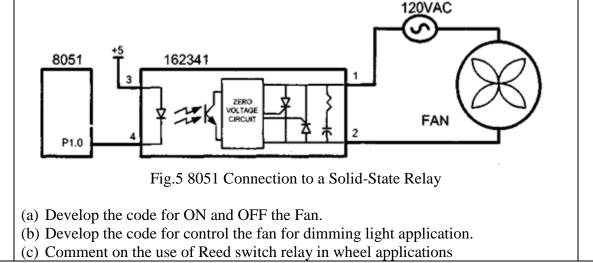


Fig.4 Connection of relay

Another widely used relay is the solid-state relay. In this relay, there is no coil, spring, or mechanical contact switch. The entire relay is made out of semiconductor materials. Because no mechanical parts are involved in solid-state relays, their switching response time is much faster than that of electromechanical relays. Another problem with the electromechanical relay is its life expectancy. The life cycle for the electromechanical relay can vary from a few hundred thousands to few million operations. Wear and tear on the contact points can cause the relay to malfunction after a while. Solid-state relays have no such limitations. Extremely low input current and small packaging make solid-state relays ideal for microprocessor and logic control switching. They are widely used in controlling pumps, solenoids, alarms, and other power applications. Some solid-state relays have a phase control option, which is ideal for motor-speed control and light-dimming applications. Fig.5 shows control of a fan using a solid-state relay (SSR).



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Semester: VIII

Max. Marks: 100

Instructions: Assume necessary data in programming if required. **SECTION A** (4 x 5 = 20 Marks)

S. No.	Attempt All the questions	Marks	CO			
Q.1	What is the different between general-purpose processor and single purpose processor?Comment on the design matrices for the product development in embedded system?					
Q.2	 Draw the structure for assembly language program flow and discuss the steps to burn the program in microcontroller. OR Assume that the word "UPES" is burned into ROM locations starting at 200H and the program is burned into ROM locations starting at 0. Analyze the method to support the 					
Q.3	program functionality and state where "UPES" is stored after this program is run, also develop the code for same.Comments on the different data types used in 8051 Embedded 'C' programming. Write					
-	an 8051 C program to send the hex values for the ASCII characters of 0, 1, 2, 3, 4, 5, A, B, C and D to port P1.	4	CO4			
Q.4	Find the time delay generated by the following subroutine for 8051 microcontroller, If XTAL = 11.0592 MHz. Suggest the best techniques to increase the delay obtained for the subroutine and estimate value. HERE: MOV R0, # 200 AGAIN: DJNZ R0, AGAIN RET	4				
Q.5	Comment on the different addressing modes employed in 8051 microcontroller. Examine the stack for 8051 microcontroller. Show the contents of the register and SP after execution of PUSH 4 instructions. All values are in hex. After PUSH 2 After PUSH 1 After PUSH 4 $\begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \\ 60 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 62 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 61 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 61 \\ 61 \end{bmatrix} = \begin{bmatrix} 63 \\ 61 \end{bmatrix} = \begin{bmatrix} 63$	4	CO3			

	SECTION B (8 x 5 = 40 Marks)				
	Attempt All the questions				
Q.6					
Q.7	Explain the use of line driver IC MAX-232 and DB-9 connector used in serial communication and interface with 8051 microcontroller.	8	CO4		
Q.8	Develop the data path architecture for the GCD controller for the two numbers $X = 40$ and $Y = 50$. Discuss the state table and FSMD. Also compare the custom GCD with the GCD running on a 300 MHz processor with two operand inductions and one clock cycle per instruction.	8	CO2		
Q.9	 Interface the stepper motor to 8051 microcontroller with the help of optoisolator. A switch is connected to pin 2.7 of 8051 microcontroller. Write a program to monitor the status of switch and perform the followings (a) If SW = 0, the stepper motor moves clockwise. (b) If SW= 1, the stepper motor moves counterclockwise. 	8	CO5		
Q.10	What is Semaphore? Explain the different types of Semaphore.	8	CO2		
Q.11	Attempt any two of the followings (Case Studies) The interfacing of a hex keypad to 8051/8085 microcontroller/ microprocessor is very essential while designing embedded system projects which requires character or				
	numeric input or both. For examples projects like digital code lock, numeric calculator etc. $f(x) = \int_{R_1}^{R_1} \int_{R_2}^{R_2} \int_{R_3}^{R_4} \int_{R_4}^{R_4} \int_{R_4}^{R_$	20	CO3		

	the key are connected gets shorted. For example if key 1 is pressed row R1 and column							
	C1 gets shorted and so				• •	•		
	known as column scanning. In this method a particular row is kept low (other rows are kept high) and the columns are checked for low. If a particular column is found low							
	kept high) and the columns are checked for low. If a particular column is found low then that means that the key connected between that column and the corresponding							
	row (the row that is kept low) is been pressed. For example if row R1 is initially kept							
	low and column C1 is fe		-	-		• •		
	(c) Based on the discus				• •	-		
	(d) WAP to display all and microcontroller		al values and	i characters.	. Use any i	microprocessor		
Q.12	Programming a 7-Segn		is so easy a	as to progra	m a LED	array but here		
X	pattern should be gener		•			•		
	with cascaded mode we							
	pins of port two in order		-	-	-			
	on Port zero which can g in fig. 3(a) below.	generate mea	ningful chara	acters on /-	Segment di	isplay are listed		
	III IIg. 5(a) below.							
	<u>∖</u> ms	SB	MSB	Luggo MSB	3			
	LSB	x000 LSB	x000 LSB	x000 LSB	x000			
	0000	0 0 1000	0100	1100				
	0001	1 001	0101	1101				
		V _ 0		V_				
	0010		0110	1110				
					<u> </u>		20	CO4
	0011		0111				20	C04
		Fig 3(a)	Pattern of 7	segments				
				1 -				
				v				
		F	ig 3(b) Outp	ut				
	(d) Develop the Embed				11	-		
	in fig. 1(b) with int	terface the 80	51 microcor	ntroller using	g one segn	nent.		
	(e) Draw and discuss t	the interface of	diagram with	n the four se	gments an	d method of		
	displaying the outp	out.						
	(f) Replace the Seven	Segment wit	h 16 x 2 LCI	D. Draw the	interface of	diagram and		
	write embedded 'C	-						

Q.13 Digital systems and microcontroller pins lack sufficient current to drive the relay. While the relay's coil needs around 10 mA to be energized, the microcontroller's pin can provide a maximum of 1-2 mA current. For this reason, we place a driver, such as the ULN2803, or a power transistor between the microcontroller and the relay as shown in Fig.4

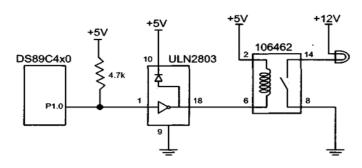
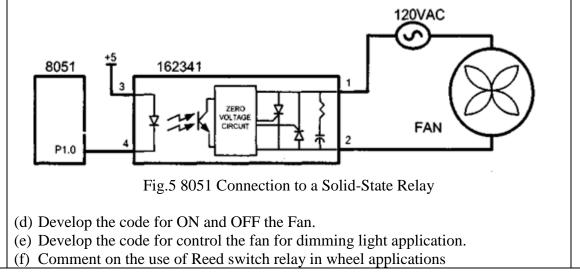


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